

/ Revised record

A	2021.05.26	ALL	MCC-MBRBL2045 MBRB2045		

/ Descriptions

TO-263

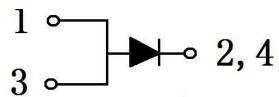
Schottky Barrier Diode in a TO-263 Plastic Package.

/ Features

Low power loss, high efficiency.

/ Applications

For use in low voltage,high frequency inverters, free wheeling, and polarity protection applications.

/ Equivalent Circuit**/ Pinning**

PIN1 Anode

PIN 2 4 Cathode

PIN 3 Anode

/ h_{FE} Classifications & Marking

See Marking Instructions.

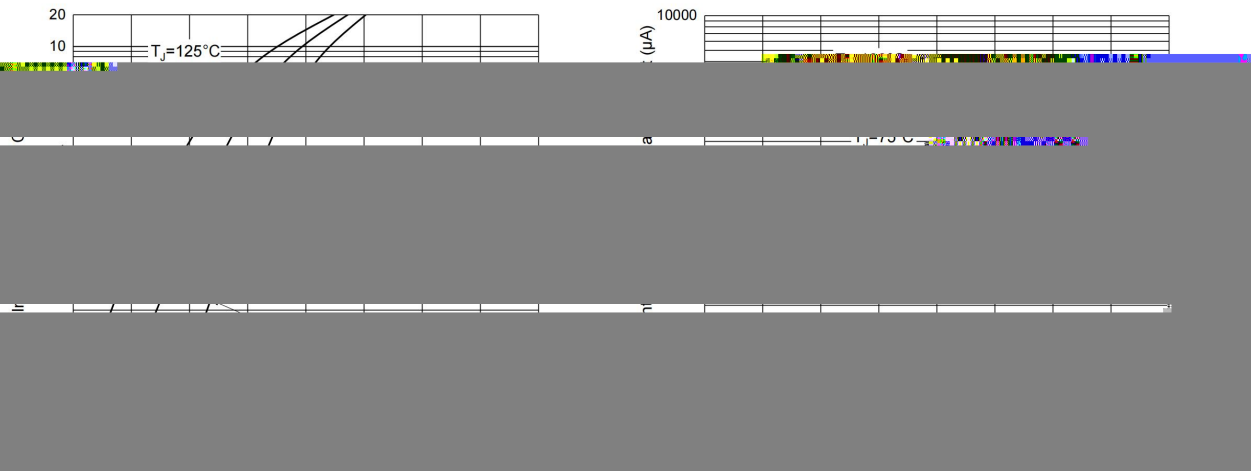
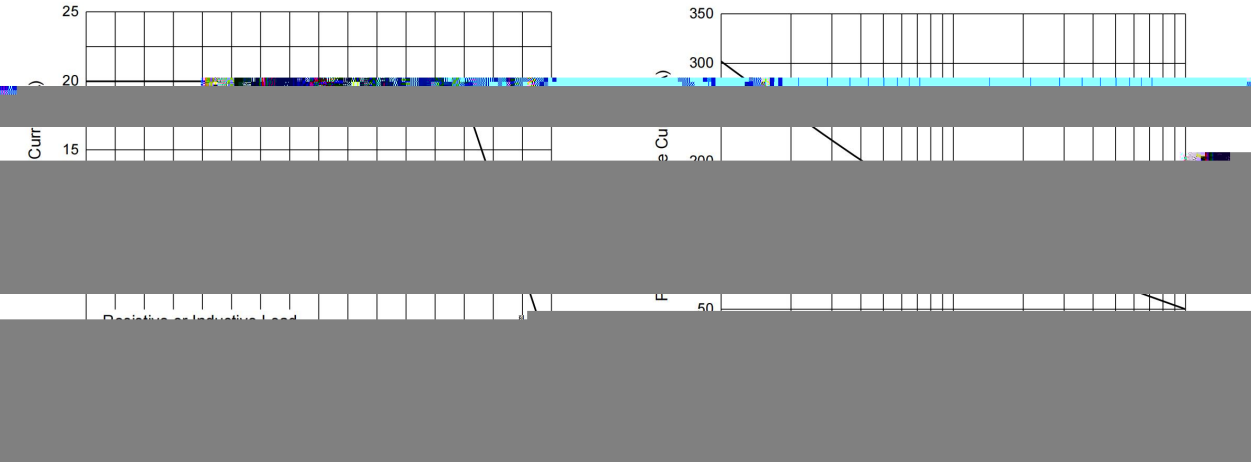
/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	45	V
Maximum RMS Voltage	V_{RMS}	31.5	V
Maximum Average forward current	$I_{F(AV)}$	20	A
Peak Forward Surge Current	I_{FSM}	300	A
Thermal Resistance Junction to Case	$R_{\theta Jc}$	1.5	°C/W
Operating junction and storage temperature range	T_{stg}	-55~+150	°C

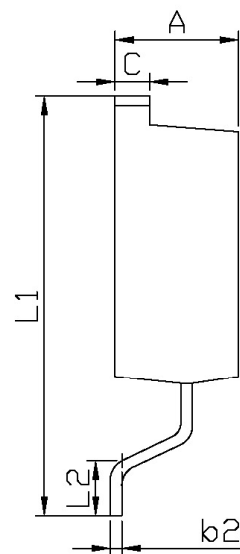
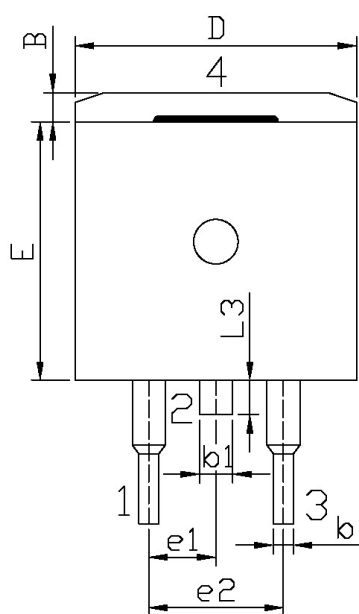
/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Breakdown voltage	V_{BR}	$I_R = 100 \mu A$	45			V
Forward Voltage	V_F	$I_F = 3A(T_A = 25^\circ C)$		0.36	0.39	V
		$I_F = 10A(T_A = 25^\circ C)$		0.43	0.48	V
		$I_F = 20A(T_A = 25^\circ C)$		0.49	0.53	V
		$I_F = 15A(T_A = 125^\circ C)$			0.47	V
Instantaneous Reverse Current	I_R	$V_R = 45V(T_A = 25^\circ C)$			60	μA
		$V_R = 10V(T_A = 25^\circ C)$			30	μA
		$V_R = 45V(T_A = 75^\circ C)$			1	mA

/ Electrical Characteristic Curve



/ Package Dimensions

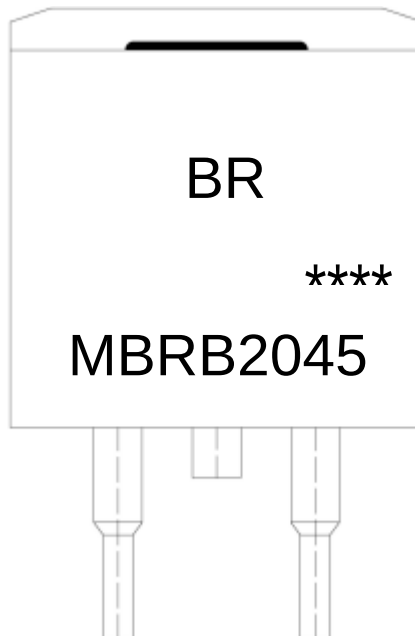


单位: mm

Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
A	4.30	4.70	E	9.00	9.40
B	1.00	1.40	e1	2.34	2.74
b	0.70	0.90	e2	4.88	5.28
b1	1.15	1.35	L1	15.00	16.00
b2	0.40	0.60	L2	2.24	2.84
C	1.20	1.40	L3	1.20	1.60
D	9.80	10.30			

TI-253

/ Marking Instructions



BR

MBRB2045

Note:

BR:

Company Code

MBRB2045

Product Type Code.

****:

Lot No. Code, code change with Lot No.

() / Temperature Profile for IR Reflow Soldering(Pb-Free)

Note:

- 11501806090sec;

2245±55±0.5sec;

3210°C/sec.
- 1.Preheating:150~180°C, Time:60~90sec.

2.Peak Temp.:245±5°C, Duration:5±0.5sec.

3. Cooling Speed: 2~10°C/sec.

/ Resistance to Soldering Heat Test Conditions

260±5°C10±1 sec.Temp.:260±5°CTime:10±1 sec

/ Packaging SPEC.

/ TUBE

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Tube 只/套管	Tubes/Inner Box 套管/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Tube 套管	Inner Box 盒	Outer Box 箱
TO-263	50	20	1,000	5				

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